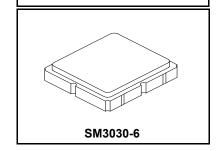


RoHS Compliance

This component is compliant with RoHS directive. This component was always RoHS compliant from the first date of manufacture.

SF1184B-1

947.5 MHz **SAW Filter**



RF Filter for GSM900

- No Matching Circuit Required
- 3.0 x 3.0 x 1.3 mm Package

Absolute Maximum Ratings

Aboolato maximum ratingo				
Rating	Value	Units		
Maximum Input Power	+15	dBm		
DC voltage between Terminals	-5 to +5	VDC		
Operable Temperature Range	-45 to +125	°C		
Specification Temperature Range	-30 to +85	°C		

Electrical Characteristics

Characteristic		Sym	Notes	Min	Тур	Max	Units
Nominal Operating Frequency		f _C			947.5		MHz
Passband	Insertion Loss (935~960 MHz)	IL			2.7	3.5	dB
	Amplitude Ripple (935~960 MHz)				0.6	1.4	dB
Attenuation	D.C.~871 MHZ			50	62.1		dB
	890~915 MHZ			30	43.9		dB
	980~1025 MHZ			25	28.6		dB
	1025~2000 MHZ			45	54.1		dB
	2000~3000 MHZ			20	26.8		dB
VSWR (935~960 MHz)					1.6	2.3	dB
Temperature Coefficient					-36		ppm/°C
Impedance at Fc ; Input Z _{IN}			1		50		Ω
Output Z _{OUT}			1		50		Ω

Case Style	SM3030-6 3 x 3 mm Nominal Footprint
Lid Symbolization (YY=year, WW=week, D=day)	459 YYWWD

Electrical Connections

Connection	Terminals
Input	2
Output	5
Ground	All others

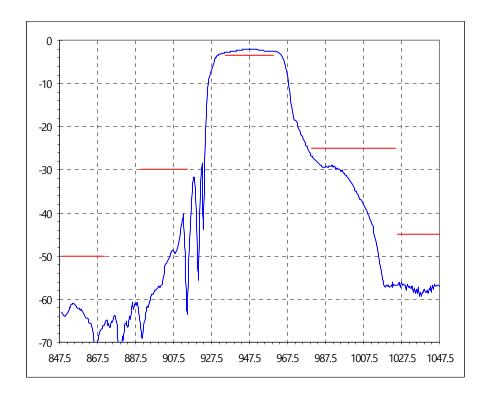
CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.

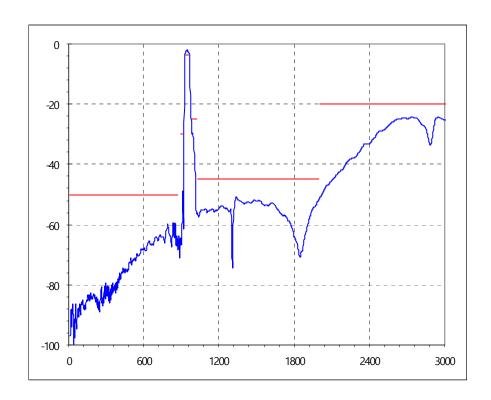
NOTES:

- Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50 Ω and measured with 50 Ω network analvzer.
- 2. Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc.
- Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.
 "LRIP" or "L" after the part number indicates "low rate initial production"
- and "ENG" or "E" indicates "engineering prototypes."
- 5. The design, manufacturing process, and specifications of this filter are
- subject to change.
 Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design.
- US and international patents may apply.
- Murata, stylized Murata logo, and Murata N.A., Inc. are registered trademarks of Murata Manufacturing Co., Ltd.

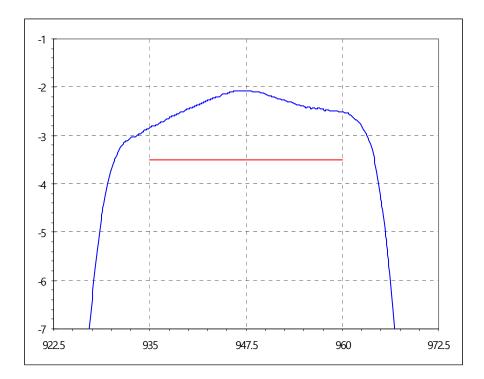
FREQUENCY CHRACTERISTICS:

1. wideband response:

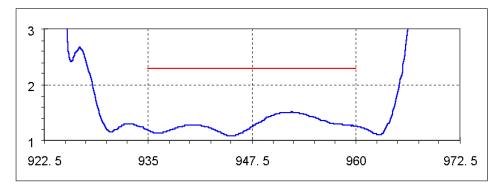


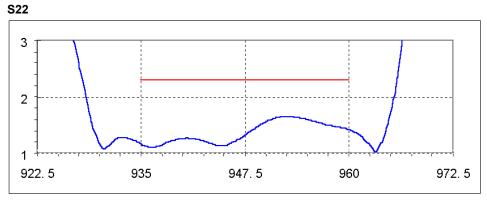


1. passband response:

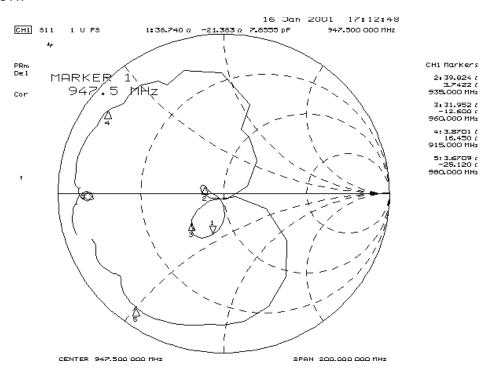


2. VSRW:

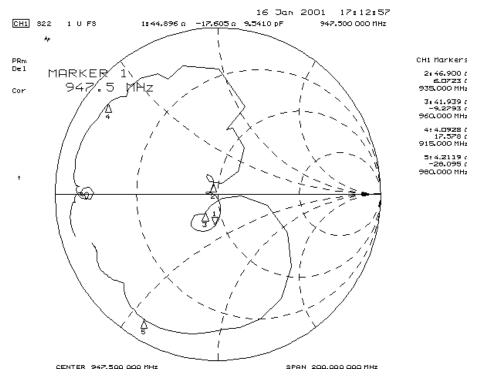




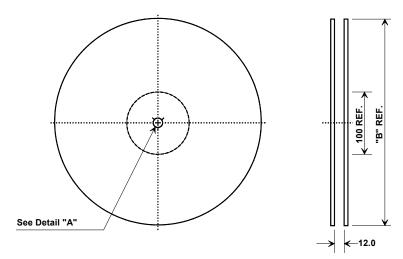
3. Smith chart of S11:



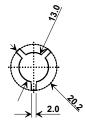
4. Smith chart of S22:

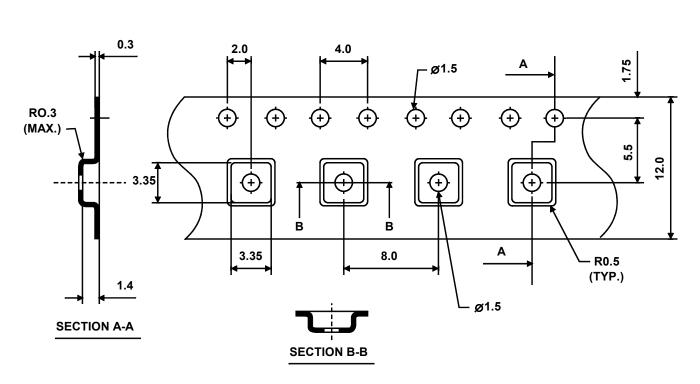


Tape and Reel Specifications



Nomi	Quantity Per Reel	
Inches	millimeters	1 01 1001
7	178	500
13	330	3000



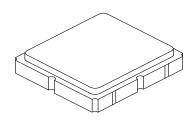


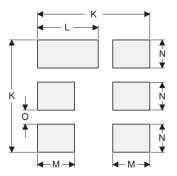
SM3030-6 Case

6-Terminal Ceramic Surface-Mount Case 3.0 X 3.0 mm Nominal Footprint

← D →

Case and PCB Footprint Dimensions



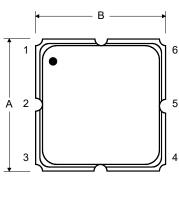


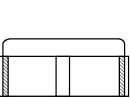
PCB FOOTPRINT

Dimension	mm			Inches			
Dilliension	Min	Nom	Max	Min	Nom	Max	
Α	2.87	3.00	3.13	0.113	0.118	0.123	
В	2.87	3.00	3.13	0.113	0.118	0.123	
С	1.12	1.25	1.38	0.044	0.049	0.054	
D	0.77	0.90	1.03	0.030	0.035	0.040	
E	2.67	2.80	2.93	0.105	0.110	0.115	
F	1.47	1.60	1.73	0.058	0.063	0.068	
G	0.72	0.85	0.98	0.028	0.033	0.038	
Н	1.37	1.50	1.63	0.054	0.059	0.064	
I	0.47	0.60	0.73	0.019	0.024	0.029	
J	1.17	1.30	1.43	0.046	0.051	0.056	
K		3.20			0.126		
L		1.70			0.067		
М		1.05			0.041		
N		0.81			0.032		
0		0.38			0.015		

Case Materials			
Solder Pad Plating	0.3 to 1.0 μm Gold over 1.27 to 8.89 μm Nickel		
Lid Plating	2.0 to 3.0 µm Nickel		
Body	Al ₂ O ₃ Ceramic		
	Pb Free		

TOP VIEW





BOTTOM VIEW

